

NCP140

LDO Voltage Regulator, 150 mA, Capacitor Free, Low Noise

The NCP140 is a 150 mA very low dropout regulator which offers excellent voltage accuracy and clean output voltage for power sensitive application. The NCP140 is very suitable for battery powered application due to very low quiescent current and virtually zero current at disable mode. This device is stable with or without output capacitors and allows minimize footprint and BOM. The XDFN4 package is optimized for use in space constrained applications.

Features

- Stable Operation with or without Capacitors
- Operating Input Voltage Range: 1.6 V to 5.5 V
- Available in Fixed Voltage Options: 1.5 V to 5 V
Contact Factory for Other Voltage Options
- $\pm 1\%$ Typical Accuracy @ 25°C
- Very Low Quiescent Current of Typ. 45 μA
- Standby Current: 0.1 μA
- Very Low Dropout: 125 mV for 3.3 V @ 150 mA
- High PSRR: 55 dB @ 1 kHz
- Available in
 - XDFN4 – 0.8 mm x 0.8 mm x 0.4 mm Package
 - XDFN4 – 1.0 mm x 1.0 mm x 0.4 mm Package
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Battery-powered Equipment
- Smartphones, Tablets
- Cameras, DVRs, STB and Camcorders

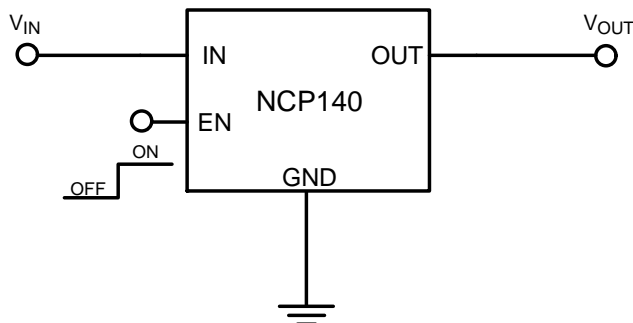


Figure 1. Typical Application Schematic



ON Semiconductor™

www.onsemi.com

MARKING DIAGRAMS



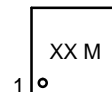
XDFN4, 0.8x0.8
CASE 711BF



X = Specific Device Code
MM = Date Code

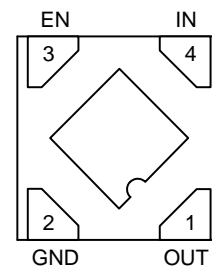


XDFN4, 1.0x1.0
CASE 711AJ



XX = Specific Device Code
M = Date Code

PIN CONNECTIONS

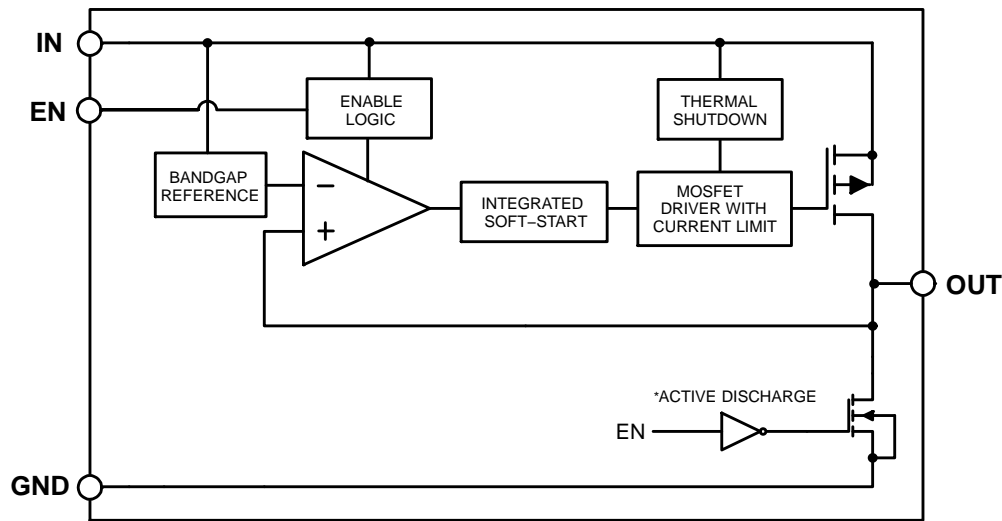


(Bottom View)

ORDERING INFORMATION

See detailed ordering and shipping information on page 13 of this data sheet.

NCP140



*Active output discharge is available only for NCP140Axxx options.

Figure 2. Simplified Schematic Block Diagram

PIN FUNCTION DESCRIPTION

Pin No.	Pin Name	Description
1	OUT	Regulated output voltage pin. A small ceramic capacitor can be connected to improve fast load transient.
2	GND	Ground pin
3	EN	Driving EN over 0.9 V turns on the regulator. Driving EN below 0.4 V puts the regulator into shutdown mode.
4	IN	Input pin
-	EPAD	Expose pad must be connect to GND pin as short as possible. Soldered to a large ground copper plane allows for effective heat removal.

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage (Note 1)	V_{IN}	-0.3 V to 6	V
Output Voltage	V_{OUT}	-0.3 V to $V_{IN} + 0.3$ V or 6 V	V
Chip Enable Input	V_{CE}	-0.3 V to 6 V	V
Output Short Circuit Duration	t_{SC}	unlimited	s
Maximum Junction Temperature	T_J	150	°C
Storage Temperature	T_{STG}	-55 to 150	°C
ESD Capability, Human Body Model (Note 2)	ESD_{HBM}	2000	V
ESD Capability, Machine Model (Note 2)	ESD_{MM}	200	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.

2. This device series incorporates ESD protection and is tested by the following methods:

ESD Human Body Model tested per EIA/JESD22-A114

ESD Machine Model tested per EIA/JESD22-A115

Latchup Current Maximum Rating tested per JEDEC standard: JESD78.

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Characteristics, XDFN4 0.8 mm x 0.8 mm Thermal Resistance, Junction-to-Air (Note 3)	$R_{\theta JA}$	252	°C/W
Thermal Characteristics, XDFN4 1.0 mm x 1.0 mm Thermal Resistance, Junction-to-Air (Note 3)	$R_{\theta JA}$	265	°C/W

3. Measured according to JEDEC board specification. Detailed description of the board can be found in JESD51-7

NCP140

ELECTRICAL CHARACTERISTICS $-40^{\circ}\text{C} \leq T_J \leq 85^{\circ}\text{C}$; $V_{IN} = V_{OUT(NOM)} + 0.5\text{ V}$; $I_{OUT} = 1\text{ mA}$, $C_{IN} = C_{OUT} = \text{none}$, unless otherwise noted. $V_{EN} = 0.9\text{ V}$. Typical values are at $T_J = +25^{\circ}\text{C}$. Min/Max values are for $-40^{\circ}\text{C} \leq T_J \leq 85^{\circ}\text{C}$ (Note 3)

Parameter	Test Conditions	Symbol	Min	Typ.	Max	Unit	
Operating Input Voltage		V_{IN}	1.6		5.5	V	
Output Voltage Accuracy	$V_{OUT} \geq 1.8\text{ V}$, $T_J = 25^{\circ}\text{C}$	V_{OUT}		± 1		%	
	$V_{OUT} < 1.8\text{ V}$, $T_J = 25^{\circ}\text{C}$			± 20		mV	
	$V_{OUT} \geq 1.8\text{ V}$, $-40^{\circ}\text{C} \leq T_J \leq 85^{\circ}\text{C}$		-2		+2	%	
	$V_{OUT} < 1.8\text{ V}$, $-40^{\circ}\text{C} \leq T_J \leq 85^{\circ}\text{C}$		-50		+50	mV	
Line Regulation	$V_{OUT(NOM)} + 0.5\text{ V} \leq V_{IN} \leq 5.5\text{ V}$	LineReg		1.0	5.0	mV	
Load Regulation	$I_{OUT} = 0\text{ mA}$ to 150 mA	LoadReg		10	30	mV	
Dropout Voltage (Note 5)	$I_{OUT} = 150\text{ mA}$	$V_{OUT(NOM)} = 1.8\text{ V}$	V_{DO}		255	390	mV
		$V_{OUT(NOM)} = 3.3\text{ V}$			125	220	
Output Current Limit	$V_{OUT} = 90\% V_{OUT(NOM)}$	I_{CL}		230		mA	
Short Circuit Current	$V_{OUT} = 0\text{ V}$	I_{SC}		250		mA	
Quiescent Current	$I_{OUT} = 0\text{ mA}$	I_Q		45	75	μA	
Shutdown Current	$V_{EN} \leq 0.4\text{ V}$, $V_{IN} = 5.5\text{ V}$	I_{DIS}		0.1	1.0	μA	
EN Pin Threshold Voltage	EN Input Voltage "H"	V_{ENH}	0.9			V	
	EN Input Voltage "L"	V_{ENL}			0.4		
EN Pin Current	$V_{EN} = 5.5\text{ V}$	I_{EN}		0.01	1.0	μA	
Turn-On Time	$C_{OUT} = 1\text{ }\mu\text{F}$, $I_{OUT} = 150\text{ mA}$, From assertion of V_{EN} to $V_{OUT} = 98\% V_{OUT(NOM)}$	T_{ON}		100		μs	
Power Supply Rejection Ratio	$V_{IN} = 3.5\text{ V}$, $V_{OUT(NOM)} = 2.5\text{ V}$, $I_{OUT} = 10\text{ mA}$	$f = 100\text{ Hz}$	PSRR		62	dB	
		$f = 1\text{ kHz}$			55		
Output Noise Voltage	$V_{IN} = 2.3\text{ V}$, $V_{OUT(NOM)} = 1.8\text{ V}$, $I_{OUT} = 10\text{ mA}$ $f = 100\text{ Hz}$ to 100 kHz	V_N		17		μV_{RMS}	
Thermal Shutdown Temperature	Temperature increasing from $T_J = +25^{\circ}\text{C}$	T_{SD}		160		$^{\circ}\text{C}$	
Thermal Shutdown Hysteresis	Temperature falling from T_{SD}	T_{SDH}		20		$^{\circ}\text{C}$	
Output Discharge Pull-Down	$V_{EN} \leq 0.4\text{ V}$, A options only	R_{DISCH}		100		Ω	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

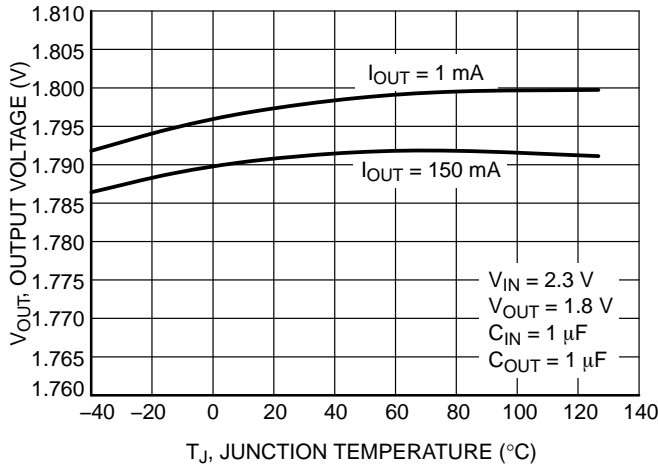
4. Performance guaranteed over the indicated operating temperature range by design and/or characterization. Production tested at $T_A = 25^{\circ}\text{C}$.

Low duty cycle pulse techniques are used during the testing to maintain the junction temperature as close to ambient as possible.

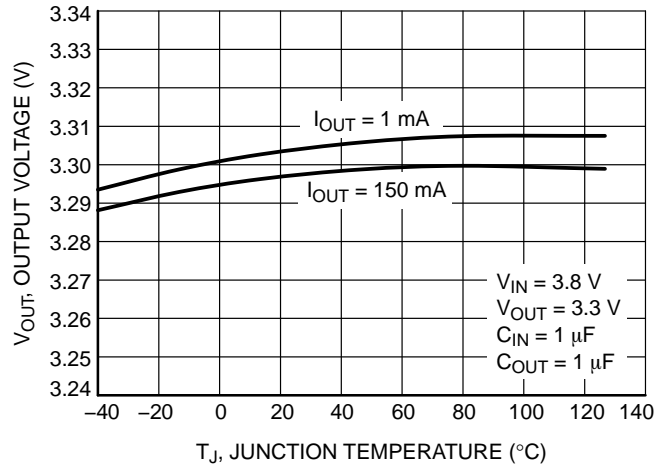
5. Dropout voltage is characterized when V_{OUT} falls 100 mV below $V_{OUT(NOM)}$.

NCP140

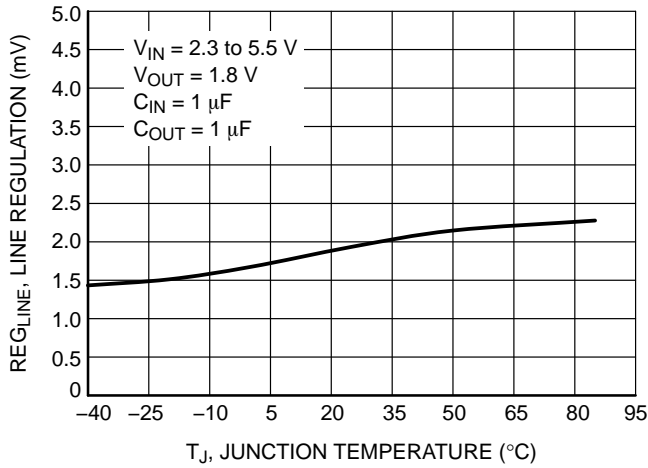
TYPICAL CHARACTERISTICS



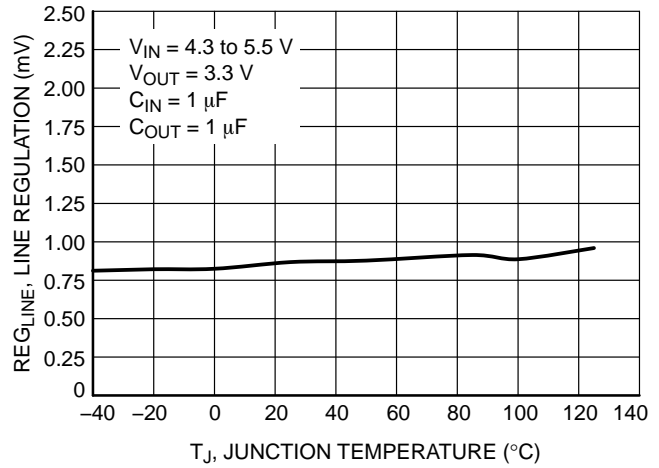
**Figure 3. Output Voltage vs. Temperature –
V_{OUT} = 1.8 V**



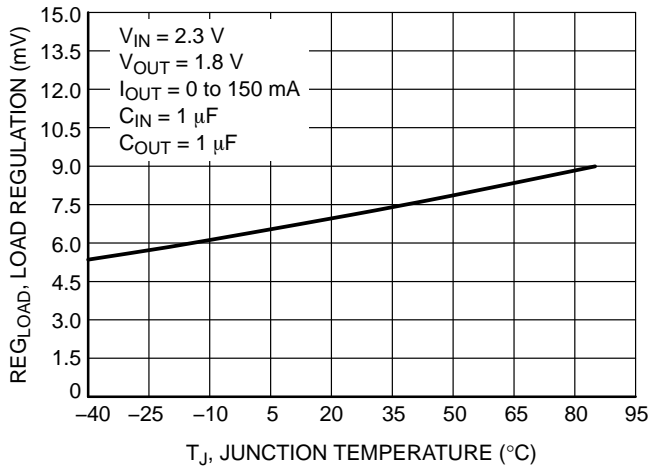
**Figure 4. Output Voltage vs. Temperature –
V_{OUT} = 3.3 V**



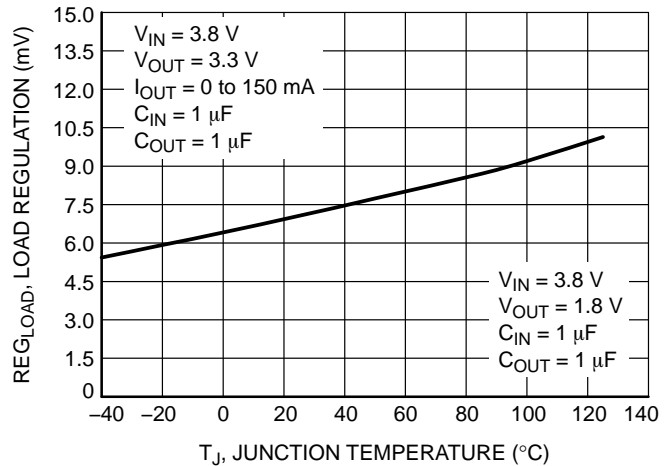
**Figure 5. Line Regulation vs. Temperature –
V_{OUT} = 1.8 V**



**Figure 6. Line Regulation vs. Temperature –
V_{OUT} = 3.3 V**



**Figure 7. Load Regulation vs. Temperature –
V_{OUT} = 1.8 V**



**Figure 8. Load Regulation vs. Temperature –
V_{OUT} = 3.3 V**

NCP140

TYPICAL CHARACTERISTICS

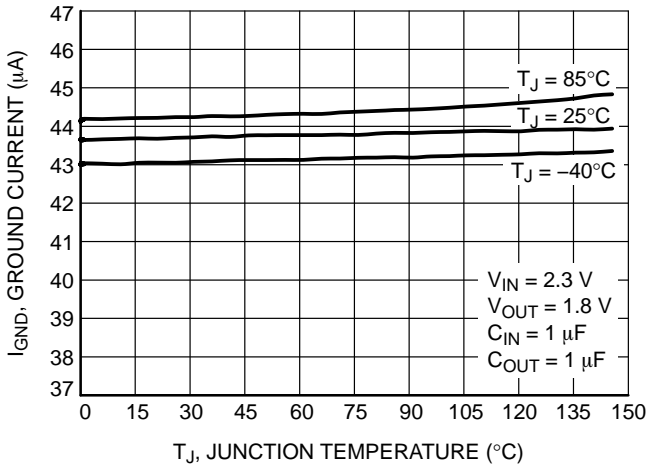


Figure 9. Ground Current vs. Load Current – $V_{OUT} = 1.8\text{ V}$

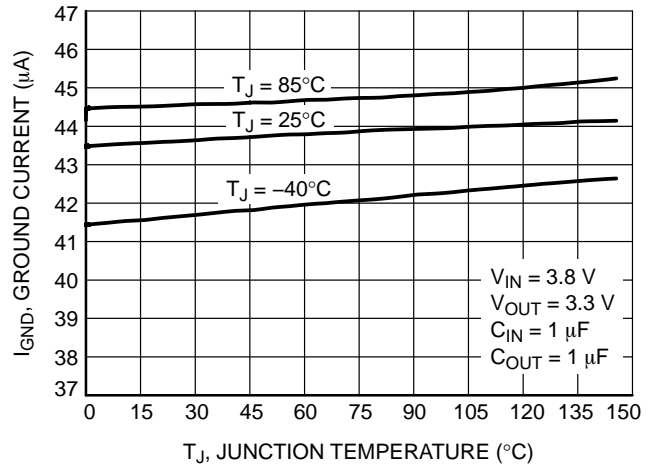


Figure 10. Ground Current vs. Load Current – $V_{OUT} = 3.3\text{ V}$

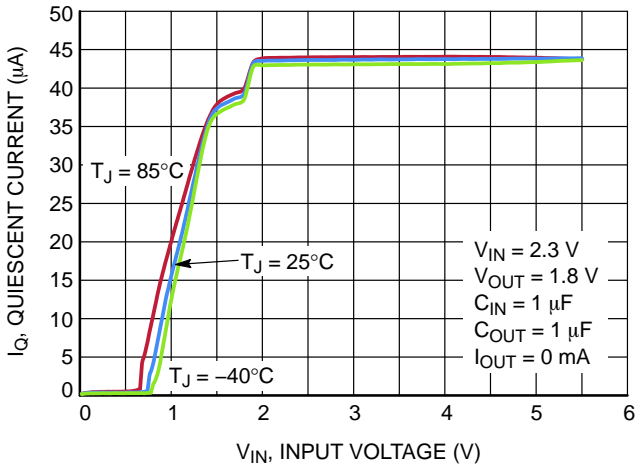


Figure 11. Quiescent Current vs. Input Voltage – $V_{OUT} = 1.8\text{ V}$

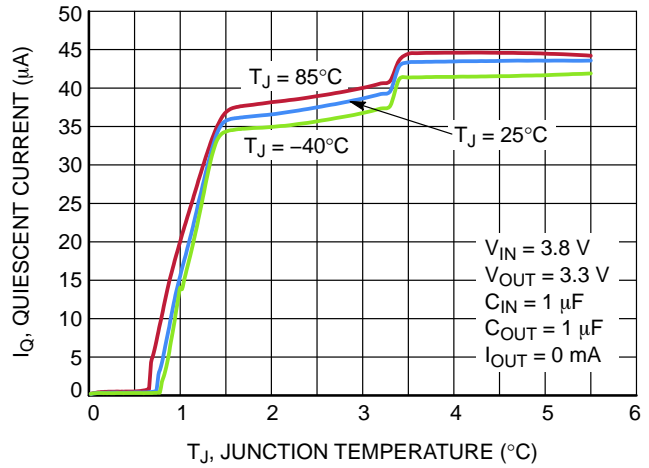


Figure 12. Quiescent Current vs. Input Voltage – $V_{OUT} = 3.3\text{ V}$

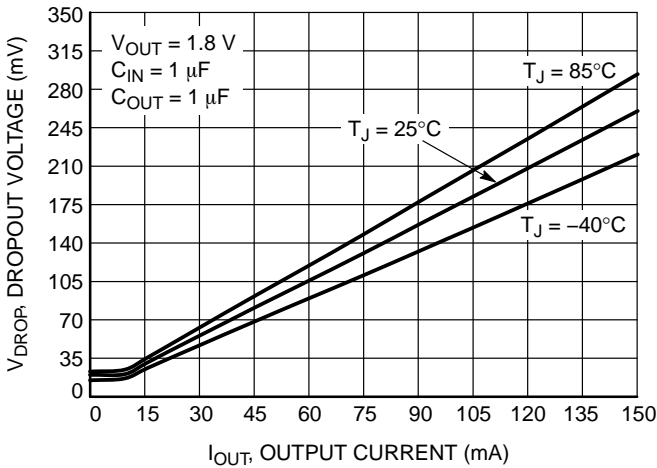


Figure 13. Dropout Voltage vs. Load Current – $V_{OUT} = 1.8\text{ V}$

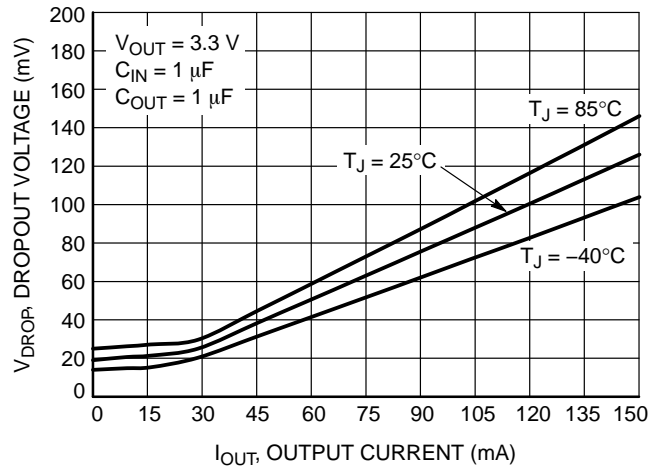


Figure 14. Dropout Voltage vs. Load Current – $V_{OUT} = 3.3\text{ V}$

TYPICAL CHARACTERISTICS

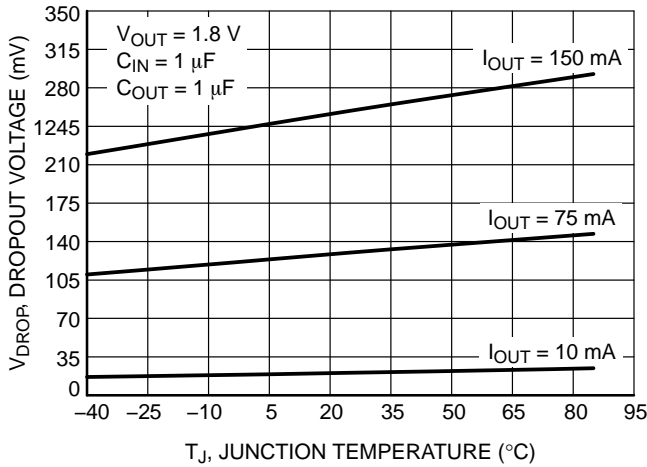


Figure 15. Dropout Voltage vs. Temperature – V_{OUT} = 1.8 V

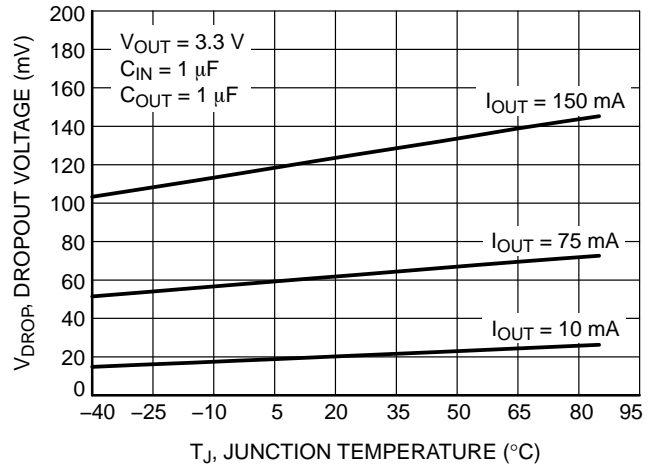


Figure 16. Dropout Voltage vs. Temperature – V_{OUT} = 3.3 V

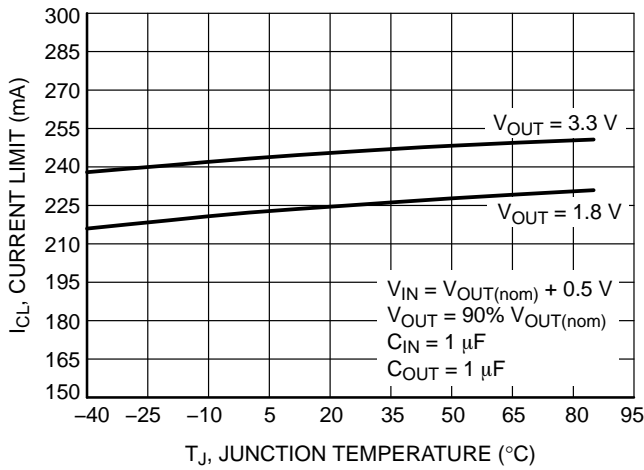


Figure 17. Current Limit vs. Temperature

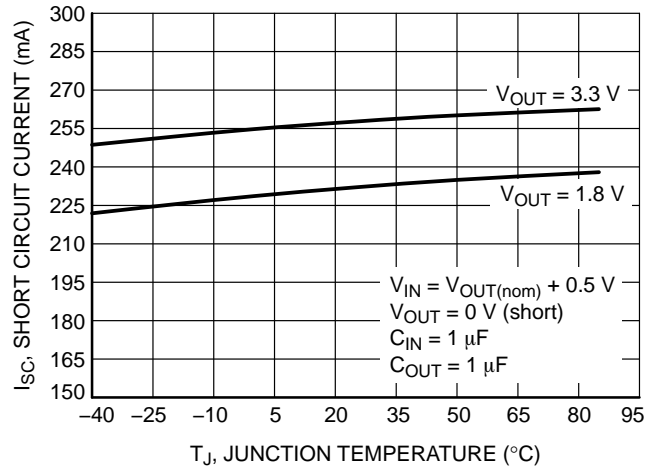


Figure 18. Short Circuit Current vs. Temperature

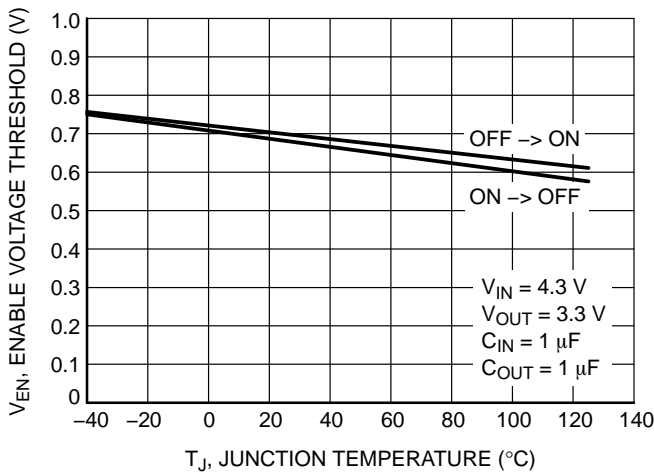


Figure 19. Enable Threshold Voltage vs. Temperature

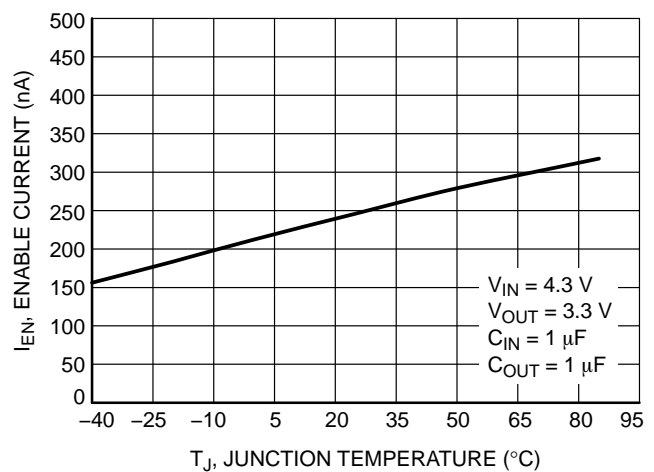


Figure 20. Enable Current vs. Temperature

NCP140

TYPICAL CHARACTERISTICS

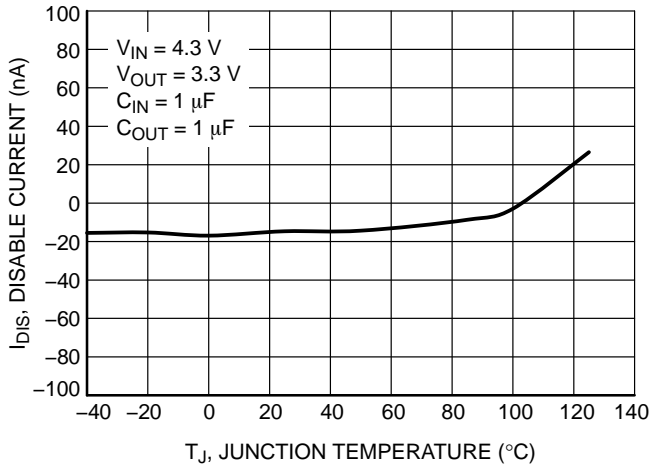


Figure 21. Disable Current vs. Temperature

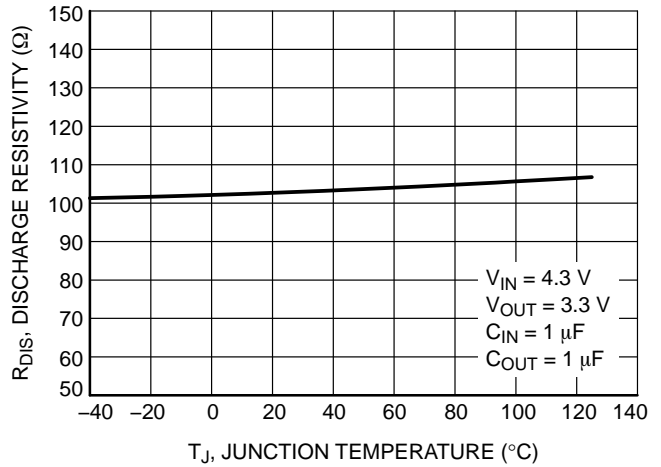


Figure 22. Discharge Resistivity vs. Temperature

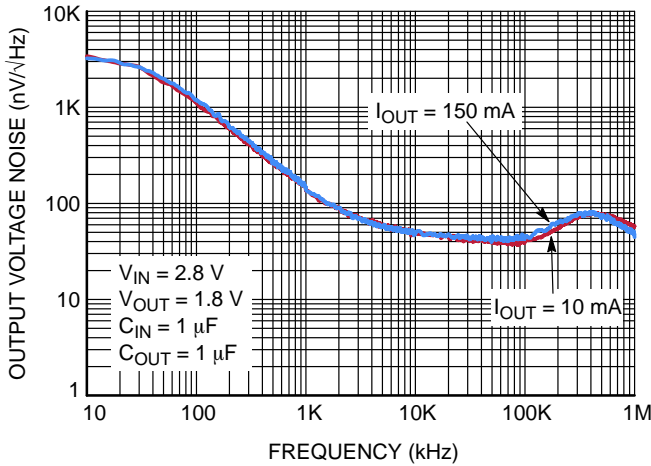


Figure 23. Output Voltage Noise Spectral Density – $V_{OUT} = 1.8 V$

I_{OUT}	RMS Output Noise (μV)	
	10 Hz – 100 kHz	100 Hz – 100 kHz
10 mA	26.21	17.94
150 mA	27.51	19.11

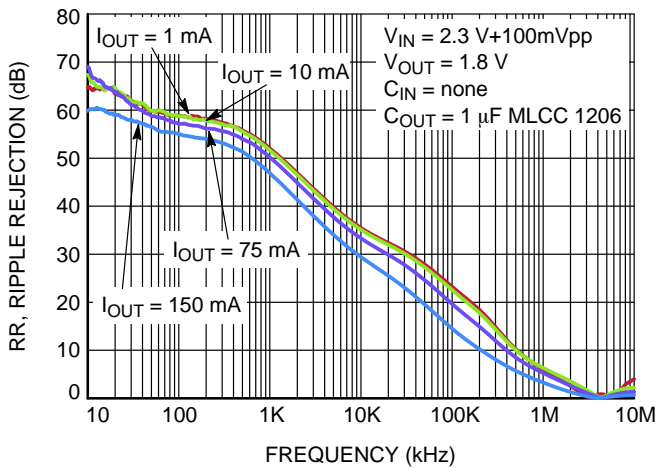


Figure 24. PSRR for Various Output Currents, $V_{OUT} = 1.8 V$

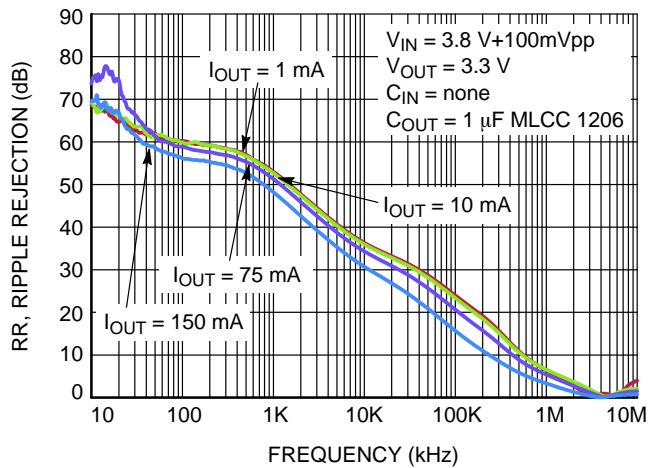


Figure 25. PSRR for Various Output Currents, $V_{OUT} = 3.3 V$

TYPICAL CHARACTERISTICS

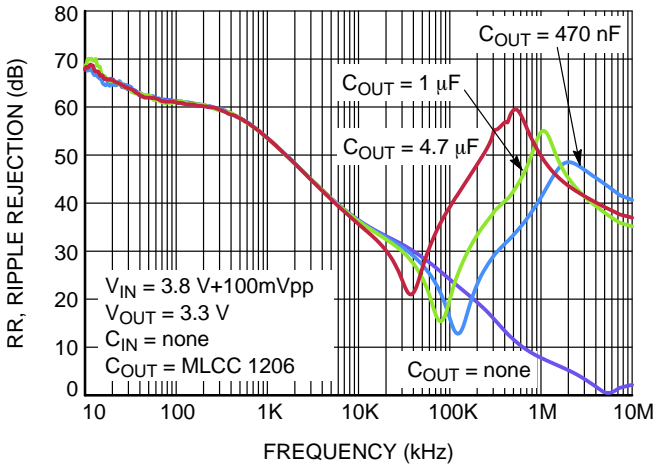


Figure 26. PSRR for Different Output Capacitor, $V_{OUT} = 3.3\text{ V}$

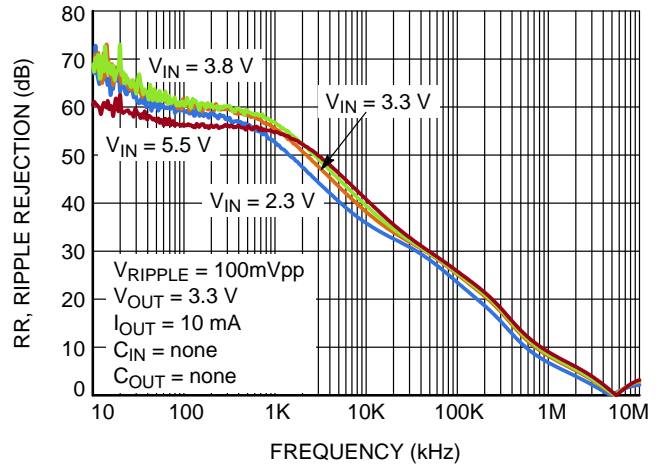


Figure 27. PSRR for Different Output V_{IN} , $V_{OUT} = 3.3\text{ V}$

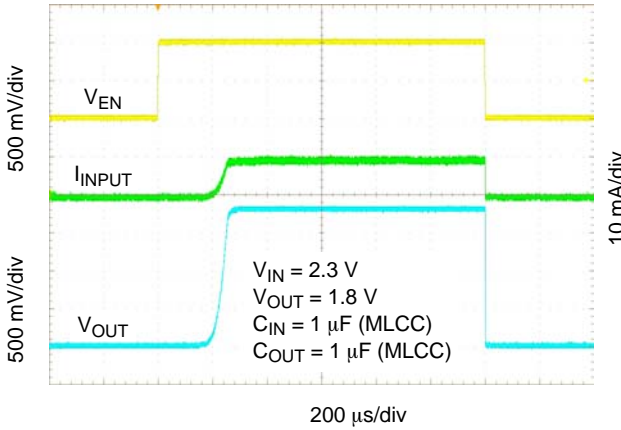


Figure 28. Enable Turn-on Response – $C_{OUT} = \text{None}$, $I_{OUT} = 10\text{ mA}$

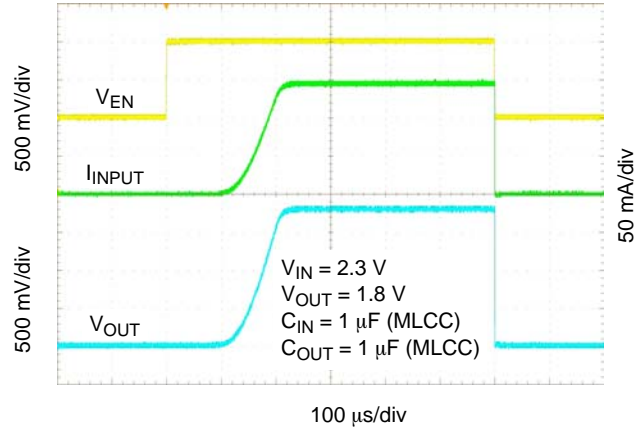


Figure 29. Enable Turn-on Response – $C_{OUT} = \text{None}$, $I_{OUT} = 150\text{ mA}$

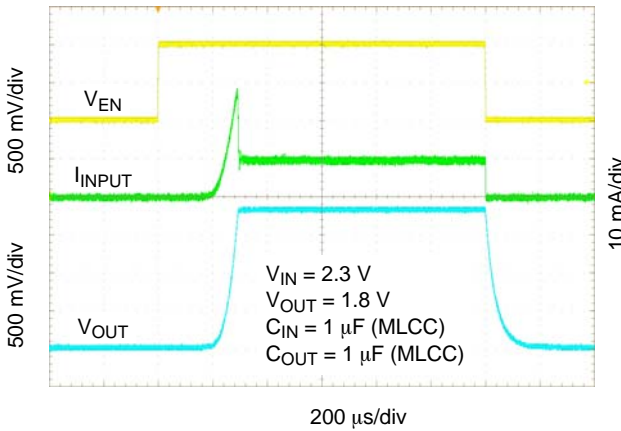


Figure 30. Enable Turn-on Response – $C_{OUT} = 470\text{ nF}$, $I_{OUT} = 10\text{ mA}$

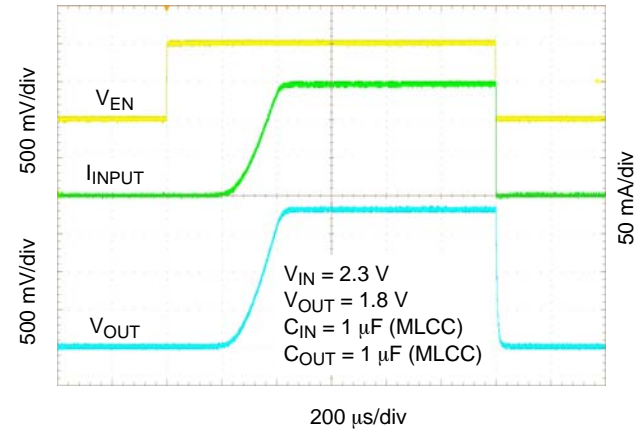


Figure 31. Enable Turn-on Response – $C_{OUT} = 470\text{ nF}$, $I_{OUT} = 150\text{ mA}$

TYPICAL CHARACTERISTICS

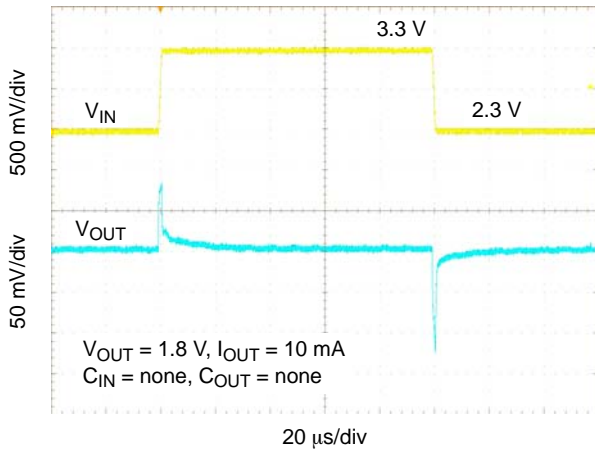


Figure 32. Line Transient Response – $C_{OUT} = \text{None}$

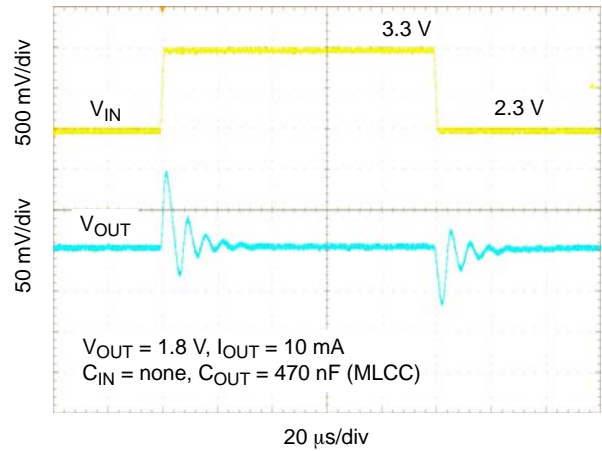


Figure 33. Line Transient Response – $C_{OUT} = 470 \text{ nF}$

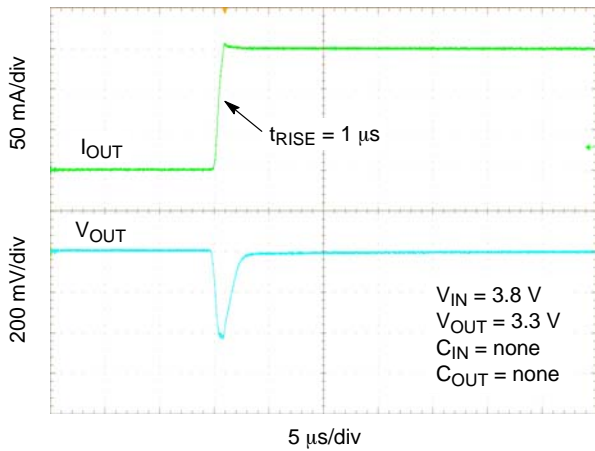


Figure 34. Load Transient Response – 1 mA to 150 mA – $C_{OUT} = \text{None}$

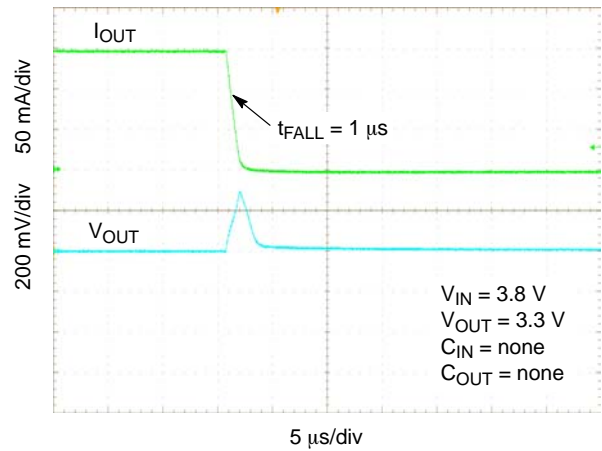


Figure 35. Load Transient Response – 150 mA to 1 mA – $C_{OUT} = \text{None}$

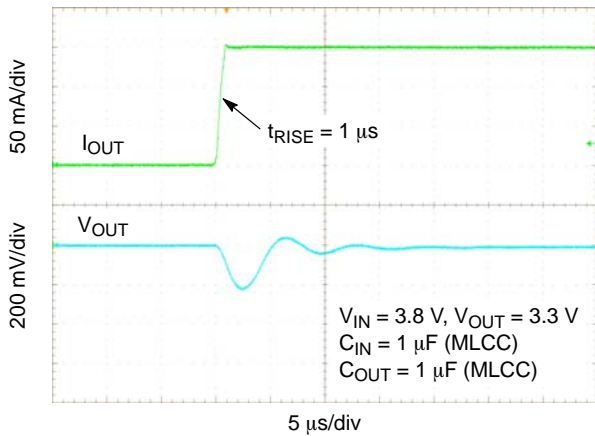


Figure 36. Load Transient Response – 1 mA to 150 mA – $C_{OUT} = 1 \mu\text{F}$

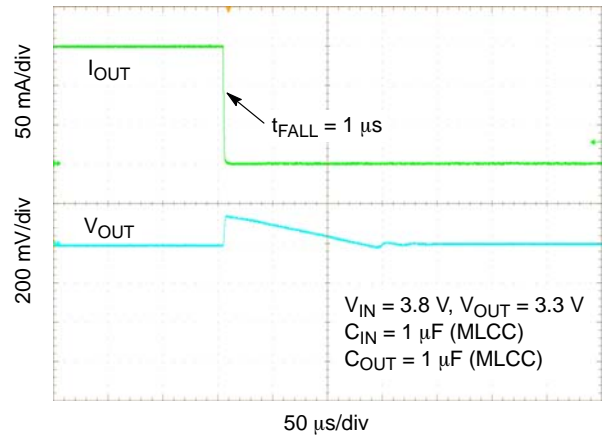


Figure 37. Load Transient Response – 150 mA to 1 mA – $C_{OUT} = 1 \mu\text{F}$

NCP140

TYPICAL CHARACTERISTICS

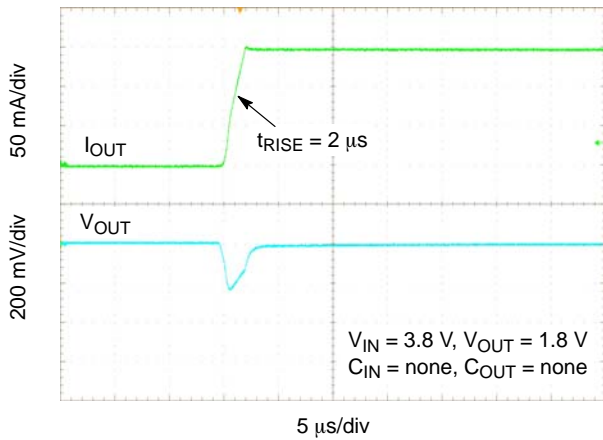


Figure 38. Load Transient Response – 1 mA to 150 mA – $t_{RISE} = 2 \mu s$

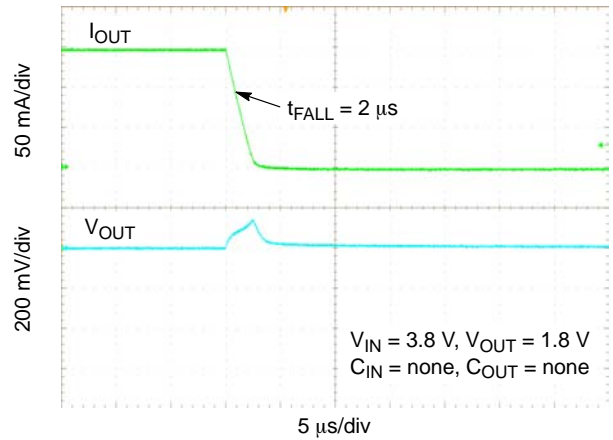


Figure 39. Load Transient Response – 150 mA to 1 mA – $t_{FALL} = 2 \mu s$

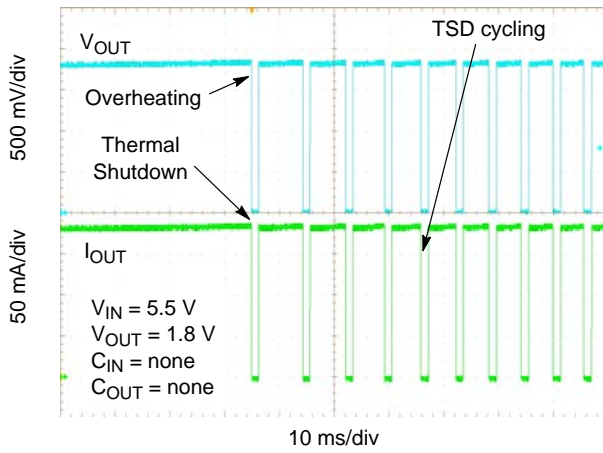


Figure 40. Over Temperature Protection – TSD

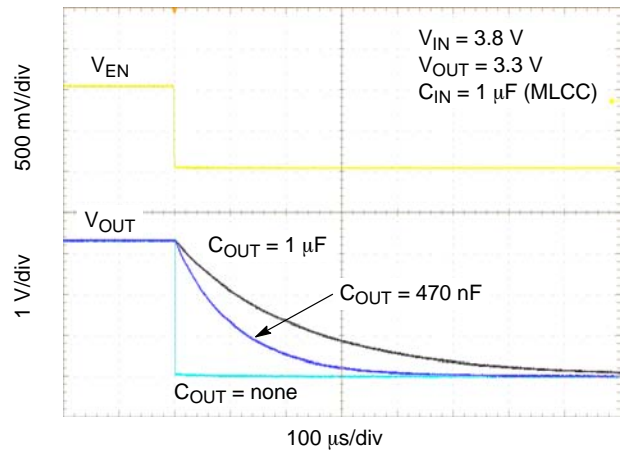


Figure 41. Enable Turn-Off

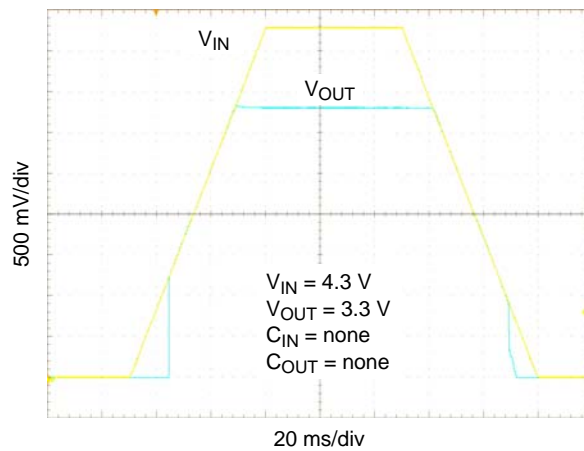


Figure 42. Slow V_{IN} Ramp

APPLICATIONS INFORMATION

General

The NCP140 is high performance low dropout regulator capable of supplying 150 mA and providing very stable output voltage with or without capacitors. The device is designed to remain stable with any type of capacitor or even without input and output capacitor. The NCP140 also offers low quiescent current and very small packages suitable for space constrained application. In connection with no capacitor requirements the regulator is very useful in wearable application, smartphones and everywhere where is high power density required.

Input and Output Capacitor Selection

In spite of the NCP140 is designed as capless device capacitors can be added to improve dynamic behavior such as fast load transient or PSRR. Recommendation for selection input and output capacitor is very similar as for high performance LDO. Low ESR ceramic capacitor is the most beneficial for improvement load transient and PSRR but suitable is almost any type of capacitor. The NCP140 remains stable with electrolytic and tantalum capacitor too.

Enable Operation

The NCP140 uses the EN pin to enable/disable its device and to deactivate/activate the active discharge function.

If the EN pin voltage is <0.4 V the device is guaranteed to be disabled. The pass transistor is turned-off so that there is virtually no current flow between the IN and OUT. The active discharge transistor is active (only A option) so that the output voltage V_{OUT} is pulled to GND through a 100 Ω resistor. In the disable state the device consumes as low as typ. 10 nA from the V_{IN} .

If the EN pin voltage >0.9 V the device is guaranteed to be enabled. The NCP140 regulates the output voltage and the active discharge transistor is turned-off.

The EN pin has internal pull-down current source with typ. value of 100 nA which assures that the device is turned-off when the EN pin is not connected. In the case where the EN function isn't required the EN should be tied directly to IN.

Output Current Limit

Output Current is internally limited within the IC to a typical 230 mA. The NCP140 will source this amount of current measured with a voltage drops on the 90% of the nominal V_{OUT} . If the Output Voltage is directly shorted to ground ($V_{OUT} = 0$ V), the short circuit protection will limit the output current to approximately 250 mA. The current limit and short circuit protection will work properly over whole temperature range and also input voltage range. There is no limitation for the short circuit duration.

Thermal Shutdown

When the die temperature exceeds the Thermal Shutdown threshold ($T_{SD} - 160^{\circ}\text{C}$ typical), Thermal Shutdown event is detected and the device is disabled. The IC will remain in this state until the die temperature decreases below the Thermal Shutdown Reset threshold ($T_{SDU} - 140^{\circ}\text{C}$ typical). Once the IC temperature falls below the 140°C the LDO is enabled again. The thermal shutdown feature provides the protection from a catastrophic device failure due to accidental overheating. This protection is not intended to be used as a substitute for proper heat sinking.

Power Dissipation

As power dissipated in the NCP140 increases, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material, and the ambient temperature affect the rate of junction temperature rise for the part.

The maximum power dissipation the NCP140 can handle is given by:

$$P_{D(\text{MAX})} = \frac{[85^{\circ}\text{C} - T_A]}{\theta_{JA}} \quad (\text{eq. 1})$$

The power dissipated by the NCP140 for given application conditions can be calculated from the following equation:

$$P_D \approx V_{IN}(I_{\text{GND}}@I_{\text{OUT}}) + I_{\text{OUT}}(V_{IN} - V_{\text{OUT}}) \quad (\text{eq. 2})$$

NCP140

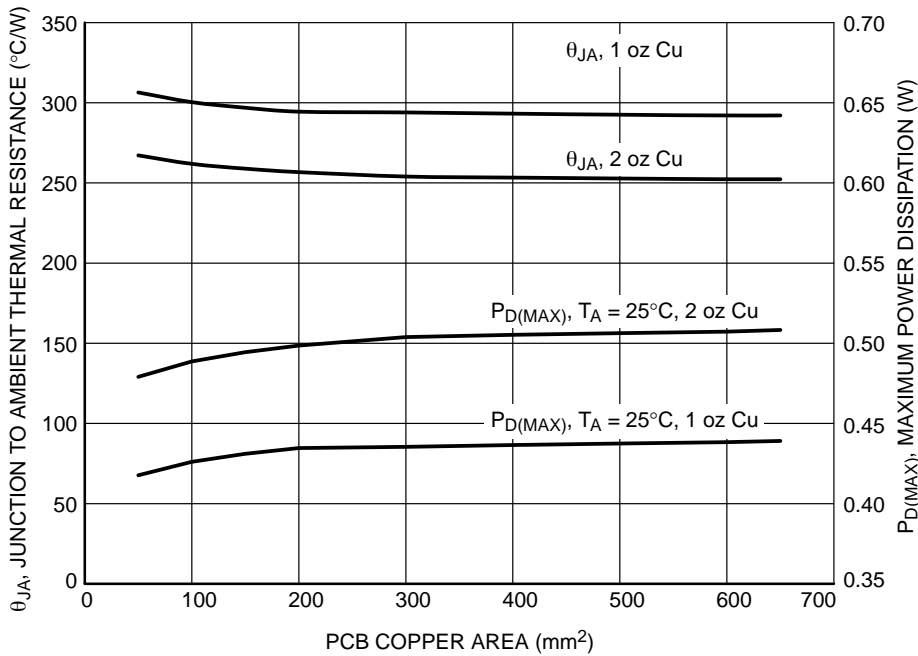


Figure 43. θ_{JA} and $P_{D(MAX)}$ vs. Copper Area (XDFN4– 0.8 x 0.8 mm)

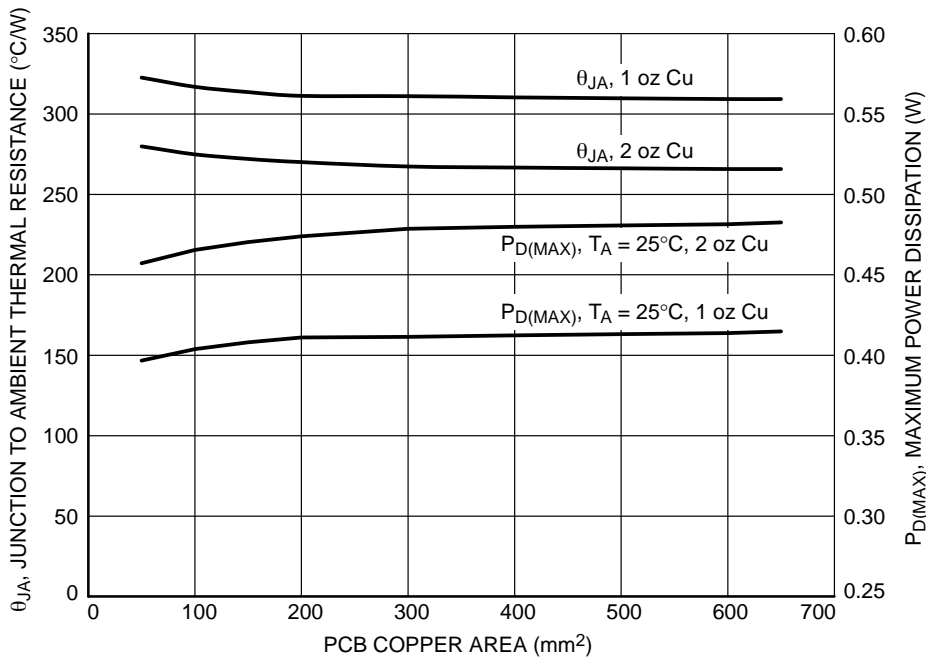


Figure 44. θ_{JA} and $P_{D(MAX)}$ vs. Copper Area (XDFN4– 1 x 1 mm)

Reverse Current

The PMOS pass transistor has an inherent body diode which will be forward biased in the case that $V_{OUT} > V_{IN}$. Due to this fact in cases, where the extended reverse current condition can be anticipated the device may require additional external protection.

Turn-On Time

The turn-on time is defined as the time period from EN assertion to the point in which V_{OUT} will reach 98% of its

nominal value. This time is dependent on various application conditions such as $V_{OUT(NOM)}$, C_{OUT} , T_A .

PCB Layout Recommendations

Larger copper area connected to the pins will improve the device thermal resistance and improve maximum power dissipation. The actual power dissipation can be calculated from the equation above (Equation 2). Expose pad should be tied the shortest path to the GND pin.

NCP140

ORDERING INFORMATION

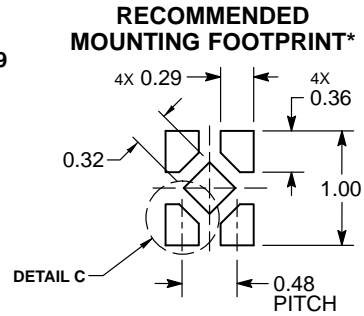
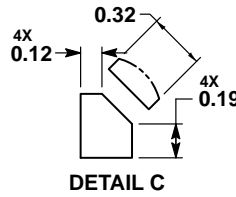
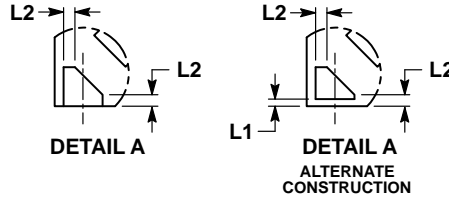
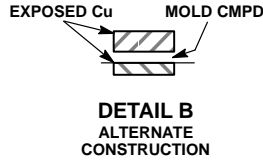
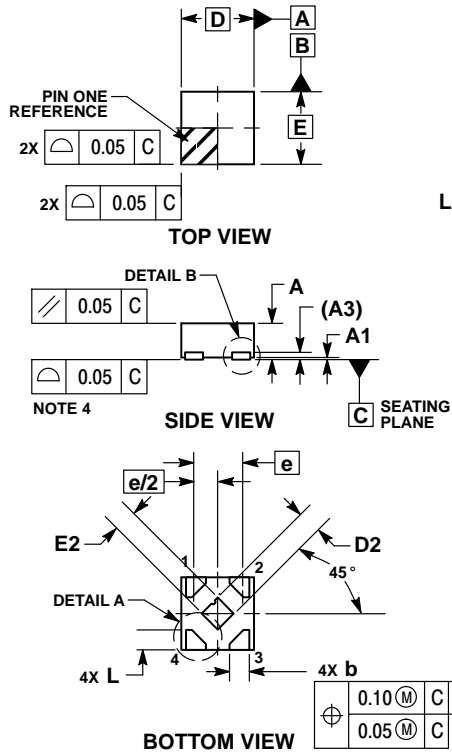
Device	Nominal Output Voltage	Description	Marking	Package	Shipping†
NCP140AMXC180TCG	1.8 V	Active Output Discharge	GA	XDFN4 (Pb-Free) CASE 711BF	3000 / Tape & Reel
NCP140AMXC280TCG	2.8 V		GC		
NCP140AMXC300TCG	3.0 V		GE		
NCP140AMXC330TCG	3.3 V		GD		
NCP140BMXC330TCG	3.3 V	Without Active Output Discharge	G2		
NCP140AMXD180TCG	1.8 V	Active Output Discharge	GA	XDFN4 (Pb-Free) CASE 711AJ	3000 / Tape & Reel
NCP140AMXD280TCG	2.8 V		GC		
NCP140AMXD300TCG	3.0 V		GE		
NCP140AMXD330TCG	3.3 V		GD		
NCP140BMXD330TCG	3.3 V	Without Active Output Discharge	G2		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NCP140

PACKAGE DIMENSIONS

XDFN4 0.8x0.8, 0.48P
CASE 711BF
ISSUE O



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINALS.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

MILLIMETERS		
DIM	MIN	MAX
A	0.33	0.43
A1	0.00	0.05
A3	0.127	REF
b	0.17	0.27
D	0.80	BSC
D2	0.20	0.30
E	0.80	BSC
E2	0.20	0.30
e	0.48	BSC
L	0.17	0.27
L1	—	0.10
L2	—	0.06 REF

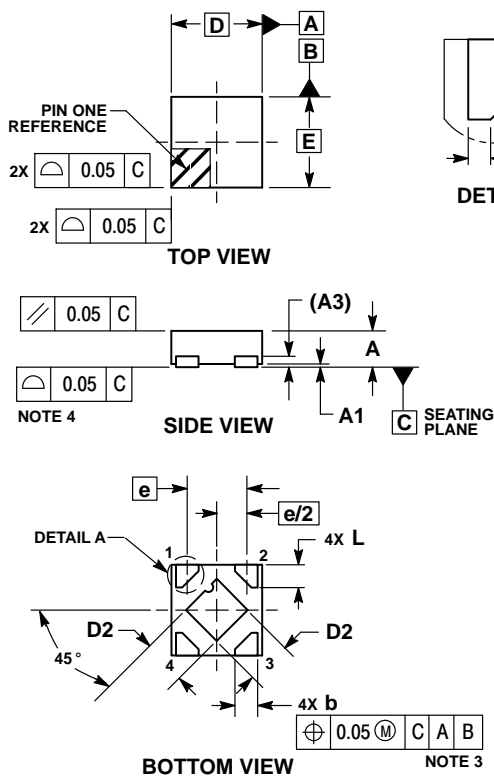
DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NCP140

PACKAGE DIMENSIONS

XDFN4 1.0x1.0, 0.65P CASE 711AJ ISSUE A

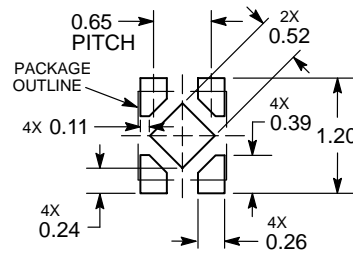


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 mm FROM THE TERMINAL TIPS.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

MILLIMETERS		
DIM	MIN	MAX
A	0.33	0.43
A1	0.00	0.05
A3	0.10 REF	
b	0.15	0.25
b2	0.02	0.12
D	1.00 BSC	
D2	0.43	0.53
E	1.00 BSC	
e	0.65 BSC	
L	0.20	0.30
L2	0.07	0.17

RECOMMENDED MOUNTING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910

ON Semiconductor Website: www.onsemi.com

Order Literature: <http://www.onsemi.com/orderlit>

For additional information, please contact your local Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ON Semiconductor:

[NCP140AMXD330TCG](#) [NCP140AMXD180TCG](#) [NCP140AMXD300TCG](#) [NCP140AMXD280TCG](#)
[NCP140AMXC330TCG](#) [NCP140BMXC330TCG](#) [NCP140BMXD330TCG](#) [NCP140AMXC280TCG](#)
[NCP140AMXC180TCG](#) [NCP140AMXC300TCG](#)